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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/623,392	07/18/2003	Peyman Hadizad	ONS00505	4620
7590 12/10/2004			EXAMINER	
James J. Stipanuk			NGUYEN, KHIEM D	
Semiconductor Components Industries L.L.C. Patent Administration Dept - MD/A700			ART UNIT	PAPER NUMBER
P.O. Box 62890			2823	
Phoenix, AZ	85082-2890			

Please find below and/or attached an Office communication concerning this application or proceeding.

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 2 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  Etheriosis of time may be windled under the provisions of 3 CPR 1.138(a), in no event, however, may a reply be timely filed Etheriosis of time may be windled under the provisions of 3 CPR 1.138(a), in no event, however, may a reply be timely filed  If the period for reply specified above is listed shan thirty (30) days, a neply which the statulatory minimum of thirty (30) days will be considered timely.  If the period for reply specified above is listed shan thirty (30) days, a neply which the statulatory prival may pay and will expire that the inhelling date of this communication.  Failure to reply within the set of extended period for reply will, by datable, cause the application to become APAHOCHED (35 U.S. § 133).  earned patent term adjustment. See 37 CFR 1.704(b).  Status  1)  Responsive to communication(s) filed on 18 July 2003.  2a)  This action is FINAL.  2b)  This action is FINAL.  2b)  This action is FINAL.  2b)  This action is reply status application for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.  Disposition of Claims  4)  Claim(s) 1-20 is/are pending in the application.  4a) Of the above claim(s) is/are allowed.  Claim(s) is/are allowed.  Claim(s) is/are allowed.  Claim(s) is/are objected to.  Claim(s) is/are objected to.  Claim(s) is/are objected to.  Claim(s) is/are objected to.  Claim(s) is/are objected to by the Examiner.  Application Papers  9) The gracification is objected to by the Examiner.  Application Papers  10) The provision of the provision of the provision of the drawing(s) is objected to by the Examiner.  Application Papers  11) All b) Some *c) Indicated the provision of the priority documents have been received.  2. Certified copies of the priority documents have been received in Application No.  3. Copies of the certified copies of the priority documents	<u> </u>						
Examiner   Khiem D Nguyen   2823		Application No.	Applicant(s)				
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The MALINO DATE of this communication appears on the cover sheet with the correspondence address Period for Reply  A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 2 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  Extensions of term may be availation under the proteines of 3 CFR 1.13(a). In no event, however, may a reply be timely filed  If the period for reply specified sheet is less than thirty (30) days, a nephy within the statutory minimum of thirty (30) skays will be considered timely.  If the period for reply specified sheet is less than thirty (30) days, a nephy with the statutory minimum of thirty (30) skays will be considered timely.  If the period for reply specified sheet is less than thirty (30) days, a nephy with the statutory minimum of thirty (30) skays will be considered timely.  If the period for reply specified sheet is less than the statutory period will apply and will apply (30) skays will be considered timely.  If the period for reply specified sheet is less than the statutory in the statutory minimum of thirty (30) skays will be considered timely.  If the period for reply specified sheet is less than the statutory minimum of thirty (30) skays will be considered timely.  If the period for reply specified sheet is less than the statutory minimum of thirty (30) skays will be considered timely.  If the period for reply specified sheet is less than the statutory minimum of thirty (30) skays will be considered timely.  If the period for reply specified sheet is less than the statutory reply reserved to the specified or reply specified and sheet the sheet	Office Action Summary		Art Unit				
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6) [] Oliver:	2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail Da	ate				

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#### **DETAILED ACTION**

### **Drawings**

The formal drawings filed on October 29<sup>th</sup>, 2003 are acceptable.

## Information Disclosure Statement

The Information Disclosure Statement filed on July 18<sup>th</sup>, 2003 has been considered.

## Claim Objections

Claim 4 is objected to because of the following informalities:

Claim 4 recites the limitation "the dielectric layer" in line 5. There is insufficient antecedent basis for this limitation in the claim. Appropriate correction is required.

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

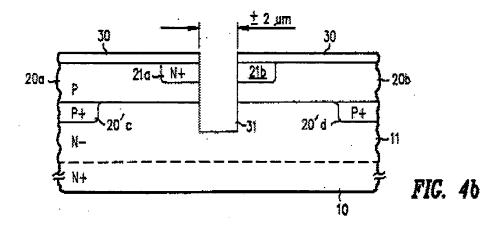
A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

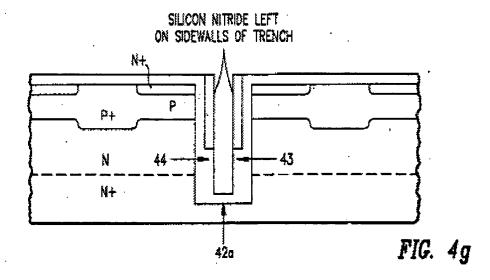
Claims 1, 4, 5, 7-12, 14-18 and 20 are rejected under 35 U.S.C. 102(b) as being anticipated by Blanchard (U.S. Patent 4,914,058).

In re claim 1, **Blanchard** discloses a method of making a semiconductor vertical FET device comprising the steps of: providing a body of semiconductor material comprising a first conductivity type (N-type), wherein the body of semiconductor material has an upper surface and a lower surface opposing the upper surface, wherein the lower surface provides a drain contact; forming a first trench 31 in the body of semiconductor material and extending from the upper surface, wherein the first trench

has a first width (unlabeled), a first depth (unlabeled) from the upper surface, first sidewalls 41, and a first bottom surface 42 (col. 3, line 60 to col. 5, line 3 and FIGS. 4a-b);



forming a second trench (unlabeled) within the first trench, wherein the second trench has a second width (unlabeled), a second depth (unlabeled) from the first surface, second sidewalls 43 and a second bottom surface 42a (col. 5, lines 4-32 and FIG. 4g);



forming a first source region 21a in the body of semiconductor material extending from the upper surface and spaced apart from the first trench; and forming a doped gate

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region (FIG. 4h) in at least a portion of the second sidewalls and the second bottom surface, wherein the doped gate region comprises a second conductivity type (col. 5, line 33 to col. 6, line 37 and FIGS 3-10).

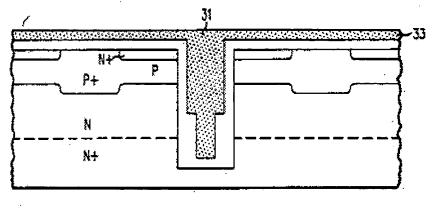
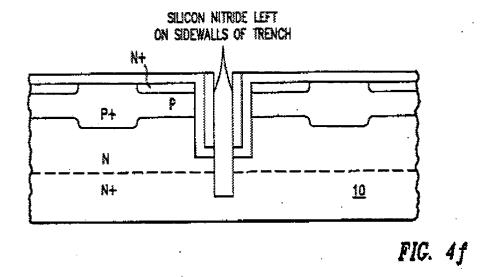


FIG. 4h

In re claim 4, <u>Blanchard</u> discloses that the step of forming the second trench comprises the steps of: depositing a spacer layer 40 over the upper surface and the first trench 31; etching back the dielectric layer to form spacers that cover first sidewalls 41 and a portion of the first bottom surface 42 leaving a self-aligned opening in the dielectric layer to expose a remaining portion of the bottom surface; and etching the second trench through the opening (col. 5, lines 4-10 and FIG. 4f).

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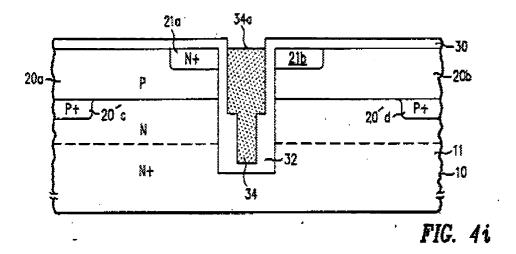


In re claim 5, **Blanchard** discloses that the step of forming the doped gate region comprises implanting a dopant species into the second sidewalls and the second bottom surface (col. 5, lines 33-48).

In re claim 7, **Blanchard** discloses that the method of claim 1 further comprising the steps of: forming a first passivation layer over the doped gate region; and forming a second passivation layer over the first passivation layer (FIGS. 4g-h).

In re claim 8, **Blanchard** discloses that the step of forming the second passivation comprises the steps of: depositing a dielectric material over the first passivation layer; and planarizing the dielectric material to form the second passivation layer (FIGS. 4g-h).

In re claim 9, <u>Blanchard</u> discloses that the method of claim 1 further comprising the step forming a second source region 21b in the body of semiconductor material spaced apart from the first trench 31, wherein the first trench is between the first 21a and the second sources 21b (col. 5, lines 49-65 and FIG. 4i).



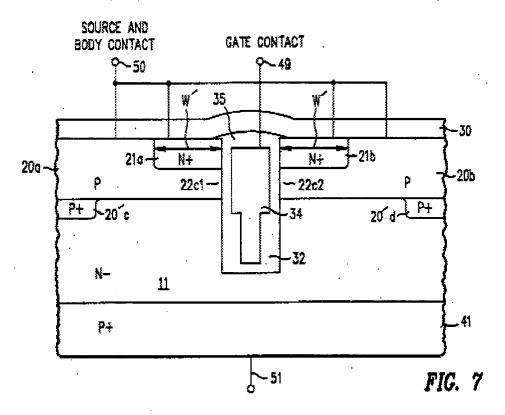
In re claim 10, <u>Blanchard</u> discloses that the step of forming the first trench 31 includes etching the first trench using one of reactive ion etching (RIE) and electron cyclotron resonance etching (col. 4, lines 47-53).

In re claim 11, **Blanchard** discloses that the step of forming the second trench includes etching the second trench using one of reactive ion etching and electron cyclotron resonance etching (col. 5, lines 3-36).

In re claim 12, <u>Blanchard</u> discloses a process of making a compound semiconductor vertical FET device comprising the steps of: forming a first groove 31 in a compound semiconductor layer of a first conductivity type, wherein the first groove has first sidewalls 41, and a first lower surface 42, and wherein the first groove extends from a first surface of the compound semiconductor layer (col. 3, line 60 to col. 5, line 3 and FIGS. 4a-b); forming a second groove (unlabeled) within the first groove, wherein the second groove has second sidewalls 43 and a second lower surface 42a (col. 5, lines 4-32 and FIG. 4g); doping the second lower surface and at least a portion of the second sidewalls with a second conductivity type dopant to form a gate region (col. 5, lines 33-

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48 and FIG. 4h); forming a first source region 21a of the first conductivity type in the compound semiconductor layer adjacent to the first groove (col. 5, lines 49-65 and FIG. 4i); forming a source contact 50 to the first source region 21a; forming a gate contact 49 coupled to the gate region 34; and forming a drain contact 51 on a second surface of the compound semiconductor layer (col. 6, line 64 to col. 7, line 15 and FIGS. 3-10);

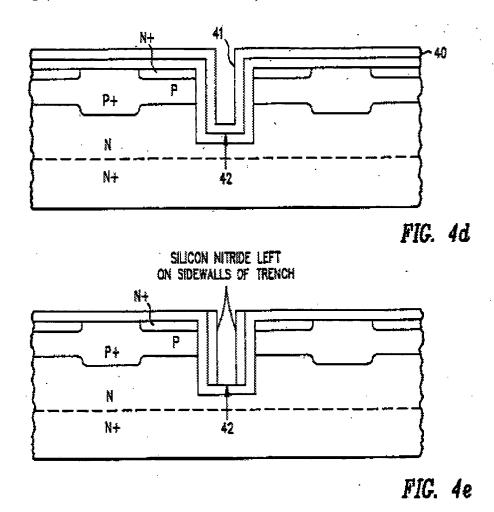


In re claim 14, **Blanchard** discloses that the process of claim 12 further comprising the step of filling the second groove and at least a portion of the first groove with a passivation layer (FIGS. 4g-h).

In re claim 15, **Blanchard** discloses that the step of doping the second lower surface and at least a portion of the second sidewalls includes ion implanting a second conductivity type dopant species (col. 5, lines 33-48).

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In re claim 16, **Blanchard** discloses that the step of forming the second groove comprises the steps of: forming spacers on the first sidewalls **41** leaving an opening over the first lower surface **42**; and etching the second groove in the compound semiconductor through the opening (col. 5, lines 4-24 and FIGS. 4d-f).

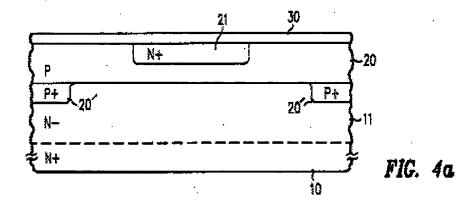


In re claim 17, **Blanchard** discloses that the steps of forming the first and second grooves including forming first and second grooves having substantially straight sidewall surfaces (FIG. 4f).

In re claim 18, **Blanchard** discloses a method for forming a compound semiconductor FET device comprising the steps of: providing a body of compound

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semiconductor material including a support wafer 10 of a first conductivity type (N-type) and a first dopant level and an epitaxial layer 11 formed over the support wafer, wherein the epitaxial layer is of the first conductivity type (N-type) and has a second dopant level lower than the first dopant level (col. 3, line 60 to col. 4, line 14 and FIG. 4a);



forming a plurality of spaced apart first doped regions 21a, 21b of the first conductivity type (N-type) in the epitaxial layer (col. 5, lines 49-65 and FIG. 4i); forming a plurality of first trenches 31 in the epitaxial layer, wherein each first trench is between a pair of first doped regions 21a, 21b (col. 5, lines 49-65 and FIG. 4i); forming a plurality of second trenches in the epitaxial layer, wherein one second trench is within one first trench (col. 5, lines 4-32 and FIG. 4g); doping at least portions of sidewall surfaces and lower surfaces of each second trench to form a plurality of doped gate regions (col. 5, line 33 to col. 6, line 37 and 4h); coupling the plurality of spaced apart first doped regions 21a, 21b, with a first contact layer 50; coupling the plurality of doped gate regions 34 to a gate contacting region 49; and forming a drain contact 51 a lower surface of the support wafer 41 (col. 6, line 64 to col. 7, line 15 and FIG. 7);

In re claim 20, **Blanchard** discloses that the step of doping the sidewall surfaces and lower surfaces includes ion implanting a dopant of the second conductivity type dopant species (col. 5, lines 33-48).

#### Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 2, 3, 6, 13, and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Blanchard (U.S. Patent 4,914,058) in view of Plumton et al. (U.S. Patent 6,229,197).

In re claim 2, **Blanchard** does not explicitly disclose that the step of providing the body of semiconductor material comprises providing a III-V semiconductor substrate having a first dopant concentration and a first epitaxial layer formed on a surface of the semiconductor substrate, wherein the first epitaxial layer has a second dopant concentration less than the first dopant concentration.

Plumton, however, discloses a method of making a semiconductor vertical FET device having the step of providing the body of semiconductor material comprises providing a III-V semiconductor substrate having a first dopant concentration and a first epitaxial layer formed on a surface of the semiconductor substrate, wherein the first epitaxial layer has a second dopant concentration less than the first dopant concentration (col. 1, line 62 to col. 2, line 64). Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention was made to combine the teaching of

Blanchard and Plumton to enable the process of providing a III-V semiconductor substrate having a first dopant concentration and a first epitaxial layer formed on a surface of the semiconductor substrate of Blanchard to be performed and furthermore to enhance device performance (col. 1, lines 57-59, Plumton).

In re claim 3, <u>Plumton</u> discloses that the step of providing the body of semiconductor material comprises providing a body of semiconductor material comprising GaAs (col. 1, line 62 to col. 2, line 64).

In re claim 6, **Plumton** discloses that the step of implanting the dopant species includes implanting one of beryllium and carbon (col. 7, lines 16-44).

In re claim 13, <u>Plumton</u> discloses that the step of forming the first groove includes forming the first groove in a compound semiconductor layer comprising one of GaAs and InP (col. 1, line 62 to col. 2, line 64).

In re claim 19, <u>Plumton</u> discloses providing the body of compound of semiconductor material includes providing a body of compound semiconductor material comprising one of GaAs and InP (col. 1, line 62 to col. 2, line 64).

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Khiem D Nguyen whose telephone number is (571) 272-1865. The examiner can normally be reached on Monday-Friday (8:00 AM - 5:00 PM).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri can be reached on (571) 272-1855. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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K.N. December 3<sup>rd</sup>, 2004

W. DAVID COLEMAN PRIMARY EYAMINED